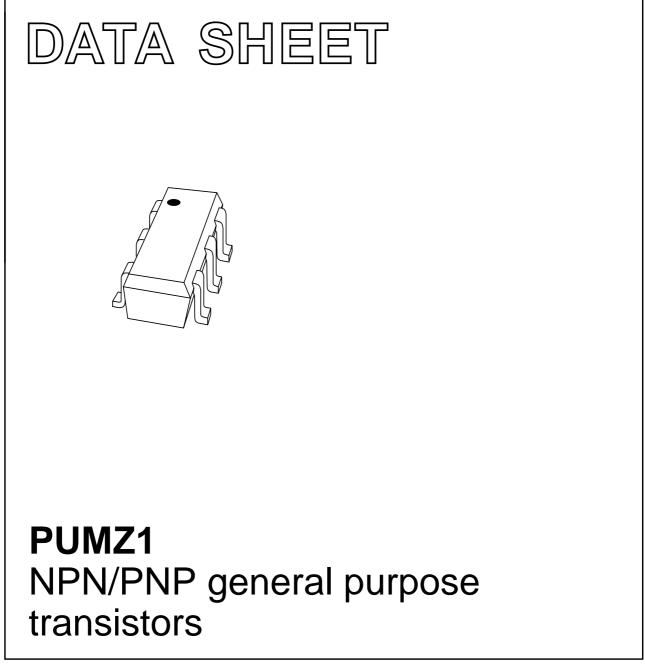
## DISCRETE SEMICONDUCTORS



Preliminary specification Supersedes data of 1999 Apr 14 2002 May 06



PUMZ1

## NPN/PNP general purpose transistors

#### **FEATURES**

- Low current (max. 100 mA)
- Low voltage (max. 40 V)
- Reduces number of components and boardspace.

#### **APPLICATIONS**

• General purpose switching and amplification.

#### DESCRIPTION

#### MARKING

TYPE NUMBER	MARKING CODE	
PUMZ1	FtZ	

### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transistor; for the PNP transistor with negative polarity					
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	40	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
I <sub>C</sub>	collector current (DC)		_	100	mA
I <sub>CM</sub>	peak collector current		-	200	mA
I <sub>BM</sub>	peak base current		-	200	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	_	200	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C
Per device	) }				·
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	-	300	mW

#### Note

1. Device mounted on an FR4 printed-circuit board.

Two independently operating NPN/PNP transistors in an
SC-88; SOT363 plastic package.

2002 May 06

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/	

### PINNING

PIN		DESCRIPTION
1, 4	emitter	TR1; TR2
2, 5	base	TR1; TR2
3, 6	collector	TR2; TR1

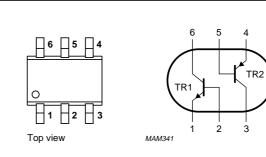


Fig.1 Simplified outline (SC-88) and symbol.

## PUMZ1

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
Per device				
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	416	K/W

#### Note

1. Device mounted on an FR4 printed-circuit board.

#### CHARACTERISTICS

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
Per transist	Per transistor; for the PNP transistor with negative polarity					
I <sub>CBO</sub>	collector cut-off current	I <sub>E</sub> = 0; V <sub>CB</sub> = 30 V	_	100	nA	
		$I_E = 0; V_{CB} = 30 V; T_j = 150 °C$	_	10	μA	
I <sub>EBO</sub>	emitter cut-off current	$I_{\rm C} = 0; V_{\rm EB} = 4 \text{ V}$	_	100	nA	
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 1 mA; V <sub>CE</sub> = 6 V	120	_		
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{\rm C} = 50 \text{ mA}; I_{\rm B} = 5 \text{ mA}; \text{ note } 1$	_	200	mV	
C <sub>c</sub>	collector capacitance	I <sub>E</sub> = i <sub>e</sub> = 0; V <sub>CB</sub> = 12 V; f = 1 MHz				
	TR1		_	1.5	pF	
	TR2		_	2.2	pF	
f <sub>T</sub>	transition frequency	$I_{C} = 2 \text{ mA}; V_{CE} = 12 \text{ V}; \text{ f} = 100 \text{ MHz}$	100	_	MHz	

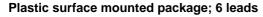
Note

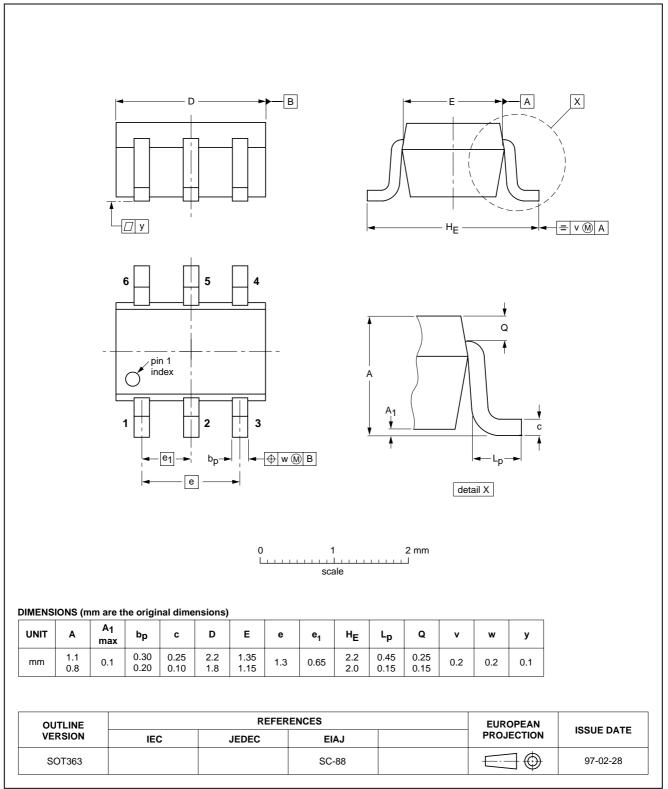
1. Pulse test:  $t_p \le 300 \ \mu s; \ \delta \le 0.02$ .

PUMZ1

## NPN/PNP general purpose transistors

### PACKAGE OUTLINE





SOT363

PUMZ1

#### DATA SHEET STATUS

DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

#### Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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